## APPLICATION DATA SHEET



Electronic Version v14 Stylesheet Version v14.0

## AP20REC' dPCT/PTO 22 MAY 2006

Title of Invention

BIOABSORBABLE PLUG IMPLANTS AND METHOD FOR BONE TISSUE REGENERATION

Application Type:

regular, utility

Attorney Docket Number: 2597.004

Correspondence address:

**Customer Number:** 

23405

\*23405\*

Continuing Data:

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**Priority Data:** 

Doc.No: 60/524,278; Country - US; Date: 2003-11-21 us-priority-claimed

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